1.5 Amp Positive Step-Down Integrated Switching Regulator

- Very Small Footprint
- High Efficiency > 85%
- Self-Contained Inductor
- Internal Short-Circuit Protection
- Over-Temperature Protection
- Fast Transient Response
- Wide Input Range

The PT78ST100 is a series of wide-input range, 3-terminal regulators.

These ISRs have a maximum output current of 1.5 Amps and an output voltage that is laser trimmed to a variety of industry standard voltages.

These 78 series regulators have excellent line and load regulation with internal short- circuit and over-temperature protection, and are offered in a variety of standard output voltages. These ISRs are very flexible and may be used in a wide variety of applications.

Package Suffix

H = Horizontal

Mount

V = Vertical Mount

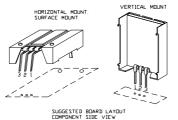
S = Surface Mount

Pin-Out Information

Pin	Function
1	$ m V_{in}$
2	GND
3	V_{out}

Vout

COM



Pkg Style 500

Ordering Information

PT78ST1 XX Y

Output Voltage

33 = 3.3 Volts

36 = 3.6 Volts

05 = 5.0 Volts **51** = 5.1 Volts

53 = 5.25 Volts **06** = 6.0 Volts

65 = 6.5 Volts **07** = 7.0 Volts

08 = 8.0 Volts **09** = 9.0 Volts

10 = 10.0 Volts **12** = 12.0 Volts

14 = 13.9 Volts **15** = 15.0 Volts

Specifications

C1

COM

Standard Application

PT78ST100

C1 = Optional 1μF ceramic C2 = Required 100μF electrolytic

C2

Characteristics			PT78ST			
(T _a = 25°C unless noted)	Symbols	Conditions	Min	Тур	Max	Units
Output Current	I_{o}	Over V _{in} range	0.1*		1.5	A
Short Circuit Current	I_{sc}	$V_{in} = V_{in} \min$	_	3.5	_	Apk
Input Voltage Range	$ m V_{in}$	$0.1 \le I_o \le 1.5 A$ $V_o = 3.3 V$ $V_o = 5 V$ $V_o = 12 V$	9 9 16		26 38 38	V V V
Output Voltage Tolerance	ΔV_{o}	Over V_{in} range, I_o =1.5A T_a = 0°C to +60°C	_	±1.0	±2.0	$%V_{o}$
Line Regulation	Reg _{line}	Over V _{in} range	_	±0.2	±0.4	%Vo
Load Regulation	Reg_{load}	$0.1 \le I_o \le 1.5A$	_	±0.1	±0.2	$%V_{o}$
V _o Ripple/Noise	V_n	V_{in} = 9V, I_{o} = 1.5A V_{o} = 5V V_{in} = 16V, I_{o} = 1.5A V_{o} = 12V	_	65 90	_	$rac{mV_{ m pp}}{mV_{ m pp}}$
Transient Response (with 100µF output cap)	t _{tr}	50% load change ${ m V_o}$ over/undershoot	_	100 5	=	μSec %V _O
Efficiency	η	$\begin{array}{lll} V_{\rm in}\!=\!10 V, I_{\rm o}\!=\!1A & V_{\rm o}\!=\!3.3 V \\ V_{\rm in}\!=\!10 V, I_{\rm o}\!=\!1A & V_{\rm o}\!=\!5 V \\ V_{\rm in}\!=\!17 V, I_{\rm o}\!=\!1A & V_{\rm o}\!=\!12 V \end{array}$		80 85 90	=	% % %
Switching Frequency	f_{o}	Over V _{in} range, I _o =1.5A	600	650	700	kHz
Absolute Maximum Operating Temperature Range	T_a	_	-40	_	+85	°C
Recommended Operating Temperature Range	T_a	Free Air Convection, (40-60LFM) At V _{in} = 24V, I _o =1.0A	-40	_	+80**	°C
Thermal Resistance	Θ_{ja}	Free Air Convection, (40-60LFM)	_	45	_	°C/W
Storage Temperature	T_s	_	-40		+125	°C
Mechanical Shock	_	Per Mil-STD-883D, Method 2002.3	_	500	_	G's
Mechanical Vibration	_	Per Mil-STD-883D, Method 2007.2, 20-2000 Hz, soldered in a PC board	_	5	_	G's
Weight	_	_	_	6.5		grams

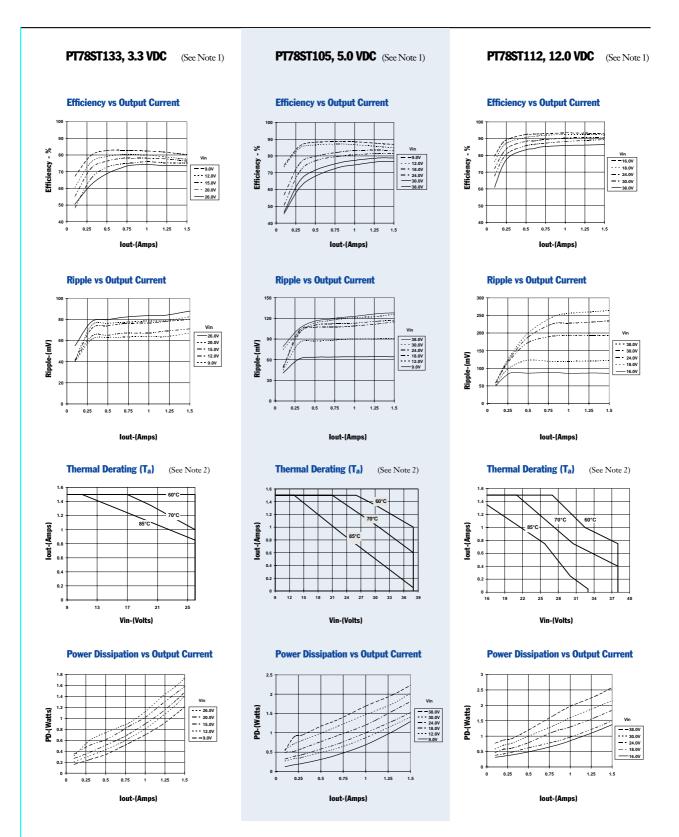
*ISR will operate down to no load with reduced specifications.

**See Thermal Derating chart.

Note: The PT78ST100 Series requires a 100µF electrolytic or tantalum output capacitor for proper operation in all applications.

PT78ST100 Series

1.5 Amp Positive Step-Down **Integrated Switching Regulator**



Note 1: All data listed in the above graphs, except for derating data, has been developed from actual products tested at 25°C. This data is considered typical data for the ISR. Note 2: Thermal derating graphs are developed in free air convection cooling of 40-60 LFM. (See Thermal Application Notes.)



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PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
PT78ST105H	ACTIVE	SIP MOD ULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST105S	ACTIVE	SIP MOD ULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM
PT78ST105ST	ACTIVE	SIP MOD ULE	EFC	3	200	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM
PT78ST105U	NRND	SIP MOD ULE	EFU	3		TBD	Call TI	Call TI
PT78ST105V	ACTIVE	SIP MOD ULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST106H	ACTIVE	SIP MOD ULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST106S	ACTIVE	SIP MOD ULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM
PT78ST106ST	ACTIVE	SIP MOD ULE	EFC	3	200	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM
PT78ST106V	ACTIVE	SIP MOD ULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST107H	ACTIVE	SIP MOD ULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST107S	ACTIVE	SIP MOD ULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM
PT78ST107ST	ACTIVE	SIP MOD ULE	EFC	3	200	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM
PT78ST108H	ACTIVE	SIP MOD ULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST108S	ACTIVE	SIP MOD ULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM
PT78ST108V	ACTIVE	SIP MOD ULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST109H	ACTIVE	SIP MOD ULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST109S	ACTIVE	SIP MOD ULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM
PT78ST109V	ACTIVE	SIP MOD ULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST110H	ACTIVE	SIP MOD ULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST110S	ACTIVE	SIP MOD ULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM
PT78ST110V	ACTIVE	SIP MOD ULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST112H	ACTIVE	SIP MOD ULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST112S	ACTIVE	SIP MOD ULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM
PT78ST112T	ACTIVE	SIP MOD ULE	EFT	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST112V	ACTIVE	SIP MOD ULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type





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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
PT78ST114H	ACTIVE	SIP MOD ULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST114S	ACTIVE	SIP MOD ULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM
PT78ST114V	ACTIVE	SIP MOD ULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST115H	ACTIVE	SIP MOD ULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST115S	ACTIVE	SIP MOD ULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM
PT78ST115ST	ACTIVE	SIP MOD ULE	EFC	3	200	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM
PT78ST115V	ACTIVE	SIP MOD ULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST133H	ACTIVE	SIP MOD ULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST133S	ACTIVE	SIP MOD ULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM
PT78ST133V	ACTIVE	SIP MOD ULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST136H	ACTIVE	SIP MOD ULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST151H	ACTIVE	SIP MOD ULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST151S	ACTIVE	SIP MOD ULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM
PT78ST153H	ACTIVE	SIP MOD ULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST153S	ACTIVE	SIP MOD ULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM
PT78ST153V	ACTIVE	SIP MOD ULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST165H	ACTIVE	SIP MOD ULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
PT78ST165S	ACTIVE	SIP MOD ULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM
PT78ST165V	ACTIVE	SIP MOD ULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type

 $^{^{(1)}}$ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.



PACKAGE OPTION ADDENDUM

9-Oct-2007

package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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